

What Is Claimed Is:

1. A carrier device for magnetizable substrates (2), in particular for processing thin-film substrates, comprising at least one magnetized base element (1), which has at least one receptacle (7) for a substrate (2).
2. The carrier device as recited in Claim 1, wherein a magnetized base metal sheet (1) is used as the base element.
3. The carrier device as recited in Claim 2, wherein the receptacle (7) for the substrate (2) is implemented in the form of a drilled hole, a stamped hole, or a passage with or without depressions in the base metal sheet (1), the shape and the dimensions of the receptacle (7) being tailored to the contour of the substrate (2).
4. The carrier device as recited in Claim 3, wherein the base metal sheet (1) has multiple drilled holes (7), stamped holes, and/or passages with or without depressions, which are positioned in a grid.
5. The carrier device for magnetizable substrates (2) having a peripheral collar (4) as recited in one of Claims 1 through 4, wherein the shape and the dimensions of the receptacle (7) are selected so that the collar (4) of substrate (2) rests only partially on the base element (1), i.e., on the edge of the receptacle (7).

6. The carrier device as recited in one of Claims 1 through 5,
wherein the base element (1) is at least partially made of $\text{Sm}_4\text{Co}_{17}$ or other ferromagnetic materials.
7. The carrier device as recited in one of Claims 1 through 6,
wherein at least one cover element (8; 10; 12 through 14) is provided, which is designed for at least one method step within the framework of the processing and may be placed on the populated base element (1) from above and/or from below.
8. The carrier device as recited in Claim 7,
wherein at least one cover element (8) for wet processes is provided and this cover element (8) has through openings (9), which ensure high media transparency.
9. The carrier device as recited in one of Claims 7 or 8,
wherein at least one cover element (10) for layer depositions is provided.
10. The carrier device as recited in one of Claims 7 through 9,
wherein at least one cover element (12 through 14) for shadow mask depositions is provided.
11. The carrier device as recited in one of Claims 7 through 10,
wherein the cover elements (8; 10; 12, 14) are implemented in the form of sheets, each sheet being provided with drilled holes, stamped holes, and/or passages with or without depressions in accordance with its function.